1.2 V Dual Channel CMOS Buffer / Translator

Description

The NB3U23C is a 2-input, 2-output buffer/voltage translator for UFS (Universal Flash Storage) in portable consumer applications such as mobile phones, tablets, cameras, etc. This dual channel CMOS buffer accepts 1.8 V CMOS input and translates it to 1.2 V CMOS output. The device is powered using single supply of 1.2 V \pm 5%.

The NB3U23C is packaged in 2 ultra-small 6-pin packages: the 6 pin SC70 and a 6 pin thin UDFN package.

Features

- Operating Frequency: 52 MHz (Max)
- Propagation Delay: 5 ns (Max)
- Low Standby Current: < 10 μA at 1.2 V V_{DD}
- Low Phase Noise Floor: -150 dBc/Hz (Typ)
- Rise/Fall Times (tr/tf): 2 ns (Max)
- ESD Protection Exceeds JEDEC Standards
 - 2000 V Human–Body Model (JS–001–2012)
 - 200 V Machine Model (JESD22-A115C)
 - 1000 V Charged–Device Model (JESDC101E)
- Operating Supply Voltage Range (V_{DD}): 1.2 V ±5%
- Operating Temperature Range (Industrial): -40°C to 85°C
- These are Pb-Free Devices



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MARKING DIAGRAMS



SC-70 SQ SUFFIX CASE 419B



23C = Device Code M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.



UDFN6 MN SUFFIX CASE 517CW



C = Device Code M = Date Code

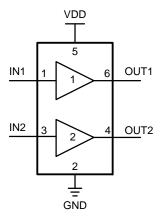


Figure 1. Simplified Logic Diagram

ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

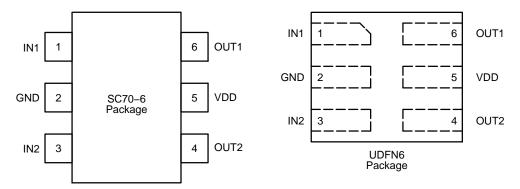


Figure 2. Pinout Diagram (Top Views)

Table 1. PIN DESCRIPTION

Number	Name	Description	
1	IN1	Input Clock Signal – Channel 1	
2	GND	Power Supply Ground (0 V)	
3	IN2	Input Clock Signal – Channel 2	
4	OUT2	Output – Channel 2	
5	VDD	Power Supply Voltage	
6	OUT1	Output – Channel 1	

Table 2. ATTRIBUTES

Charac	Value		
ESD Protection Human Body Model Machine Model Charge Device Model		2 kV min 200 V min 1 kV min	
Moisture Sensitivity (Note 1)	Level 1		
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	
Transistor Count	120		
Meets or exceeds JEDEC Spe			

^{1.} For additional information, see Application Note AND8003/D.

Table 3. MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V_{DD}	Supply Voltage			3.6	V
V _{in}	Input Voltage			$-0.5 \le V_1 \le 2.5$	V
Ι _D	Output Current			25	mA
T _A	Operating Temperature Range, Industrial			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm (Note 3) 0 lfpm 500 lfpm (Note 3)	SC70-6 UDFN-6	210 126 245 172	°C/W
θJC	Thermal Resistance (Junction-to-Case)	(Note 3)	SC70-6 UDFN-6	100 150	°C/W
T _{sol}	Wave Solder			260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 4. ELECTRICAL CHARACTERISTICS (VDD = $1.2 \pm 5\%$ V, GND = 0 V, $T_A = -40$ °C to +85°C)

Symbol	Characteristic	Conditions	Min	Тур	Max	Unit
DIDD	Power Supply Current (Single Channel Switching @ 52 MHz)	$C_L = 20 \text{ pF}$ $C_L = 5 \text{ pF}$ $C_L = 1 \text{ pF}$		2.5 1.5 1		mA
	Power Supply Current (Both Channels Switching @ 52 MHz)	$C_L = 20 \text{ pF}$ $C_L = 5 \text{ pF}$ $C_L = 1 \text{ pF}$		5 3 2		mA
l _{off}	Standby Current	Vi = V _{IH} Max or GND; V _{DD} = 1.2 V, No Output Load			10	μΑ
V _{IH}	Input High Voltage		0.65 * VDD		1.98	V
V_{IL}	Input Low Voltage		0		0.35 * VDD	V
V _{OH}	Output High Voltage	$C_L = 20 \text{ pF}$ $R_L = 100 \text{ k}\Omega$	0.75 * VDD		VDD	V
V _{OL}	Output Low Voltage	$C_L = 20 \text{ pF}$ $R_L = 100 \text{ k}\Omega$	0		0.25 * VDD	V
C _{in}	Input Capacitance				5	pF
F _{clk}	Operating Frequency Range		0		52	MHz
t _{PD}	Propagation Delay	INx to OUTx $C_L = 20 \text{ pF, } R_L = 100 \text{ k}\Omega$			5	ns
	Phase Noise Floor Density (Notes 4 and 5)	$C_L = 20 \text{ pF}$ $R_L = 100 \text{ k}\Omega$		-150		dBc/Hz
	Additive RMS Phase Jitter (Notes 5 and 6)	C_L = 20 pF R_L = 100 k Ω Offset Frequency Range: 50 kHz to 10 MHz		0.15	0.25	ps
DC	Output Duty Cycle (Note 7)	Input Duty Cycle = 50%, Min Input Slew Rate = 1 V/ns	45		55	%
tr/tf	Output Rise/Fall Times	$0.2 * V_{DD}$ to $0.8 * VDD$ $C_L = 20 \text{ pF}$ $R_L = 100 \text{ k}\Omega$			2	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{2.} Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and not valid simultaneously. If stress limits are exceeded device functional operation is not implied, damage may occur and reliability may be affected.

^{3.} JEDEC standard multilayer board – 2S2P (2 signal, 2 power).

^{4.} White noise floor.

^{5.} This parameter refers to the random jitter only.

^{6.} The output RMS phase jitter can be calculated using the following equation: (Output RMS Phase Jitter)² = (Input RMS Phase Jitter)² + (Additive RMS Phase Jitter)²

^{7.} Measured with input voltage swing from 0 V to 1.8 V.

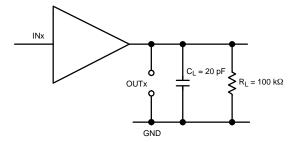


Figure 3. Typical Test Setup for Evaluation

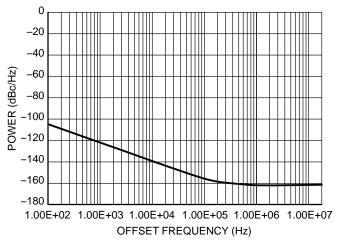


Figure 4. Typical Phase Noise Plot at 50 MHz Carrier Frequency

ORDERING INFORMATION

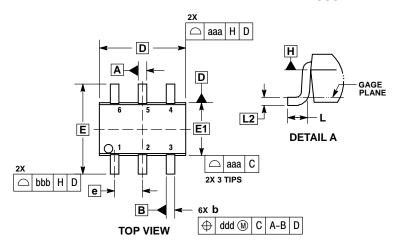
Device	Package	Shipping [†]	
NB3U23CSQTCG	SC-70-6 (Pb-Free)	3000 / Tape & Reel	
NB3U23CMNTAG	UDFN6 (Pb-Free)	3000 / Tape & Reel	

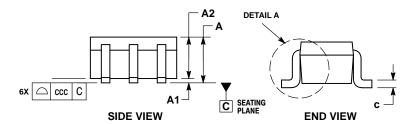
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363

CASE 419B-02 **ISSUE Y**





- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.

 4. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H.

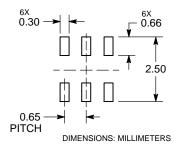
 5. DATUMS A AND B ARE DETERMINED AT DATUM H.

 6. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.

 7. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION b AT MAXIMUM MATERIAL CONDI-
- EXCESS OF DIMENSION 6 AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α			1.10			0.043
A1	0.00		0.10	0.000		0.004
A2	0.70	0.90	1.00	0.027	0.035	0.039
b	0.15	0.20	0.25	0.006	0.008	0.010
С	0.08	0.15	0.22	0.003	0.006	0.009
D	1.80	2.00	2.20	0.070	0.078	0.086
E	2.00	2.10	2.20	0.078	0.082	0.086
E1	1.15	1.25	1.35	0.045	0.049	0.053
е	0.65 BSC			0	.026 BS	С
L	0.26	0.36	0.46	0.010	0.014	0.018
L2	0.15 BSC			(0.006 BS	SC
aaa	0.15				0.006	
bbb	0.30				0.012	
CCC	0.10				0.004	
ddd	0.10				0.004	

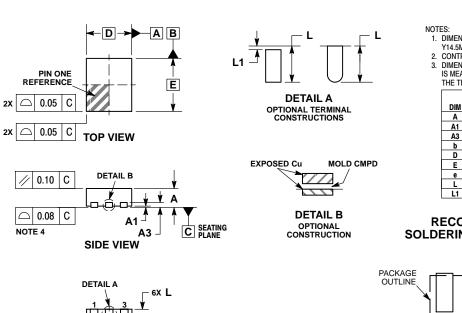
RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

UDFN6 1.2x1.4, 0.4PCASE 517CW ISSUE O



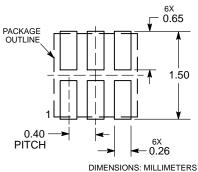
0.10 M C A B

0.05 M

- 1. DIMENSIONING AND TOLERANCING PER ASME
- Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.25MM FROM THE TERMINAL TIP.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.45	0.55	
A1	0.00	0.05	
A3	0.13 REF		
b	0.15	0.25	
D	1.20 BSC		
Е	1.40 BSC		
е	0.40 BSC		
L	0.50	0.60	
L1		0.15	

RECOMMENDED SOLDERING FOOTPRINT*



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